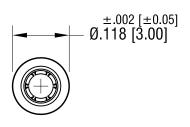
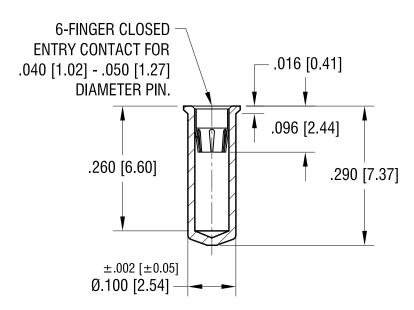
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ACTUAL SIZE







REV.

NOTES:

DATE

1. BODY: MAT'L - BRASS

2. SPRING CONTACT: MAT'L - BERYLLIUM COPPER

DESCRIPTION

3. MOUNTING HOLE DIA.: .102 [2.59]

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PART NAME	
· · · · · · · · · · · · · · · · · · ·	
MICRO JACK, SOLDER MOUNT	
MATERIAL	
AS NOTED	
FINISH TIN/LEAD DLATE	BOONE DATE 2.05.07
TIN/LEAD PLATE	APP'D LN SCALE 5X
TOLERANCES INCH [MM] CODE	DWG NO.
DECIMAL ± .005 [± 0.13] ANGULAR ± 1° UNLESS OTHERWISE SPECIFIED	1438